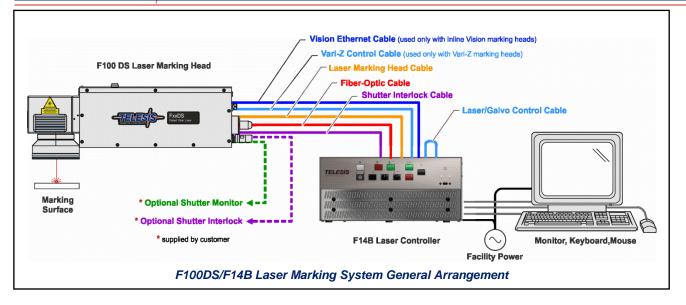


F100DS/F14B Laser Marking Systems



SYSTEM OVERVIEW

The Telesis® F100 lasers are a family of maintenance-free, Q-switched, Ytterbium fiber lasers designed for marking applications. These lasers deliver a high-power laser beam directly to the marking head via a flexible, metal-sheathed fiber cable. The fiber-based optical design and rugged mechanical design allows the Telesis F100 marking heads to operate in an industrial environment where shock, vibration, and dust are a concern.

The unique design of the F100 lasers allows for a remote beam delivery system. The galvanometer package is attached to a fiber-optic delivery system from a remote laser engine. This allows the overall package to be very small and modular.

The F100DS lasers offer these advantages:

- Standard 115/230 VAC operation
- Reliable, maintenance-free performance
- Compact size and modular construction
- Output laser beam delivery via a fiber optic cable
- Exceptional beam quality and stable output power
- Active AO Q-switching
- Sealed head to prevent dust contamination in optical chamber
- Visible red diode for aiming and dry run operations
- Air cooled
- DoD-compliant Unique Identification (UID) marking
- Dual-sensor shutter circuit

SYSTEM CONFIGURATION

The F100 laser is available with or without the Vari-Z (variable Zaxis) feature and Inline Vision. The V models have the integrated Inline Vision system called Telesis TeleView. It is a through-thelens camera system that allows on-screen viewing of the mark during setups (supervisor mode), as well as quick setup of the laser beam using the Marker Focus procedure. With the optional Read Tool added, the system can read and grade data matrix 2D bar codes.

- **F100DS Markers** provide dual-sensor shutter circuits, plus dual channel shutter monitor, and shutter interlock
- **F100DSV Markers with Inline Vision** provide dual-sensor shutter circuits, plus shutter monitor, shutter interlock with Inline Vision options (2).
- **F100DSZ Vari-Z Markers** provide the same capabilities as the DS markers, but include the Vari-Z features. The Vari-Z laser marking heads are equipped with a dynamic focusing unit. Dynamic focusing allows you to define various focal distances for the lens on your marker.
- F100DSZV Vari-Z Markers with Inline Vision provide the same capabilities as the Vari-Z with the optional Inline Vision.

The basic laser system consists of the following components:

- The Laser Marking Head includes the shutter assembly, visible red aiming diode, galvanometer assembly, camera, and flat-field lens.
- The **F14B Laser Controller** contains the laser source unit, fiber optic cable assembly, circuit boards, the galvo controller board, and other electrical components. Controllers for the Vari-Z markers contain an additional 3D galvo controller board. The
- The **front panel** of the controllers provides controls for the operator. The **back panel** of the controller provides an interface panel for connecting the laser marking head and other external devices.
- The **System Computer** is embedded in the laser controller. The Merlin[®]II LS Laser Marking Software is pre-installed on the embedded computer.
- The **Monitor**, **Keyboard**, and **Mouse** are supplied by Telesis for connection to the laser controller.

The modular design allows for major components to be easily serviced if required.

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SPECIFICATIONS

F100/ F14B System Specifications

| | adionio |
|-----------------------------------|---|
| Compliance | CDRH, CE |
| Laser Type | Class 4 Q-switched Ytterbium |
| | fiber |
| Wavelength: | |
| F100DS | 1055-1075 nanometers |
| Long-Term Output Power Drift | $\leq \pm 5\%$ |
| Power Requirements | 95 to 250 VAC, 50/60 Hz |
| System Power (total): | |
| F100DS | < 600W |
| Maximum Supply Voltage | 254 VAC |
| Supply Voltage Fluctuation | $<\pm 10\%$ with clean ground |
| Operational Temperature | 18° to $35^{\circ}C$ (64° to $95^{\circ}F$) |
| Recommended Temperature | 20° to $25^{\circ}C$ (68° to 77°F) |
| Ambient Relative Humidity | 10% to 85% non-condensing |
| Fiber Optic Cable: not detachable | |
| F100DS | 3 m (9.8 ft) |
| | 5 m (16.4 ft) optional |
| Laser Marking Head Cable | 5 m (16.4 ft), detachable |
| Vari-Z Control Cable | 5 m (16.4 ft), detachable |
| Peripherals | Monitor, Keyboard, Mouse |
| | |

F14B Laser Controller Specifications

| 444.5 x 208.7 x 511.1 mm |
|--------------------------------|
| (17.50 x 8.22 x 20.12 in) |
| See the F14B Laser Controller |
| Dimensions drawing |
| Approximately 18.64 kg (41 lb) |
| Air cooled, fan |
| |

System Computer Specifications

| Operating System | Windows® 10 Embedded |
|--------------------|--|
| Operator Interface | Telesis Merlin II LS Software |
| Processor | 3 GHz Intel [®] Core [™] I5 |
| RAM | 8 GB |
| Comm Ports | |
| | Four USB ports (back panel) One USB port (front panel) |
| Circuit Cards | Laser/Galvo Controller Board 3D Laser Galvo Controller Board (Vari-Z markers only) |

F100 Laser Marking Head Specifications

Dimensions (Length x Width)

| Dimensions (Lengin x muin) | |
|----------------------------|---|
| DS, and DSV heads | 606.8 x 128.9 mm (23.89 x 5.076 in) |
| DSZ, and DSZV heads | 732.8 x 160.5 mm (28.85 x 6.320 in) |
| Dimensions (Height) | Dependent on laser marking head model and lens selection: |
| DS, and DSV heads | F100 lens: 154.57 mm (6.084 in) F160 lens: 152.65 mm (6.009 in) F163 lens: 168.98 mm (6.650 in) F254 lens: 182.38 mm (7.178 in) F330 lens: 186.76 mm (7.350 in) F350 lens: 172.01 mm (6.771 in) F420 lens: 186.49 mm (7.342 in) |
| DSZ, and DSZV heads | F100 lens: 143.59 mm (5.654 in) F160 lens: 141.63 mm (5.577 in) F163 lens: 157.86 mm (6.216 in) F254 lens: 171.39 mm (6.749 in) F330 lens: 174.81 mm (6.884 in) F350 lens: 160.05 mm (6.303 in) F420 lens: 175.35 mm (6.905 in) Note: Height dimensions are determined by the head height + the A column value in the <i>Laser</i> <i>Marking Head Dimensions</i> drawings |
| Surrounding Envelope | See <i>Laser Marking Head</i> Dimensions drawings. |

Mounting Weight (approximate)

| DS, and DSV heads | 7.64 kg (16.84 lb) |
|---------------------|------------------------------|
| DSZ, and DSZV heads | 11.46 kg (25.26 lb) |
| Mounting | Factory-tapped M6-1.00 holes |
| Positioning | Visible (red) aiming diode |
| Field Resolution | 16 bit (65535 data points) |
| Galvanometer | |
| Repeatability | < 22 micro radian |
| Marking Field Size | Lens-dependent |
| | See Laser Marking Head |
| | Dimensions drawings. |

SYSTEM OPTIONS

- Vari-Z (Dynamic Laser Focus)
- Auxiliary two-axis controller
- Manually operated tool post for vertical (Z-axis) adjustment
- Programmable tool post for vertical (Z-axis) adjustment (requires two-axis controller)
- Rotary drive fixture for rotational (Theta-axis) adjustment (requires two-axis controller)
- Remote push button station (start/abort)
- Externally mounted focus-finder diode
- Workstation/work area enclosure
- Fume extraction systems
- TeleView Inline Vision (when applicable)
- Ring light
- Read Tool Command (must have TeleView)

SYSTEM SETUP

The following procedures provide a general overview of the installation process. Refer to the

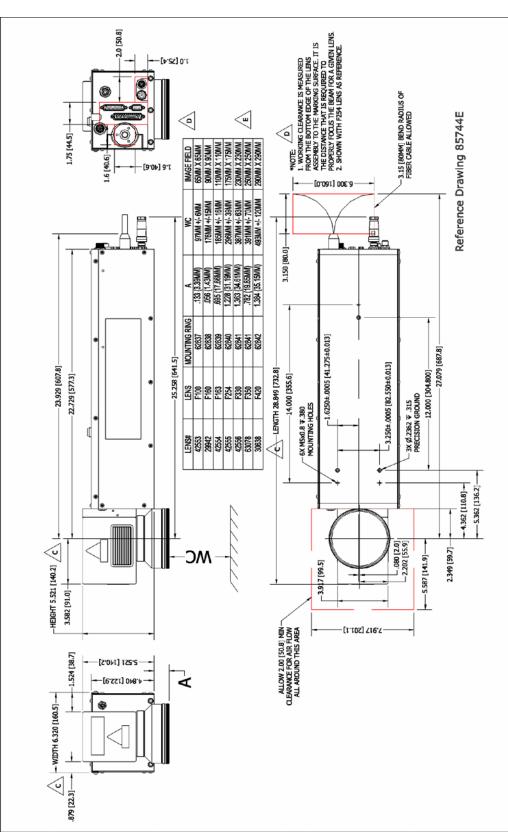
F100//F14B Installation & Maintenance Manual for complete installation details.



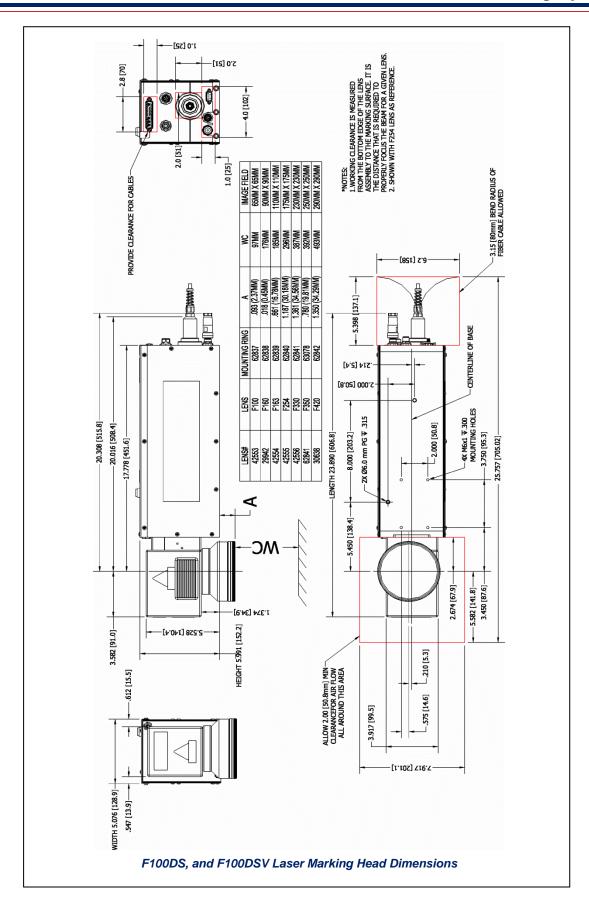
Never connect any power cable to power source until all system connections are made.

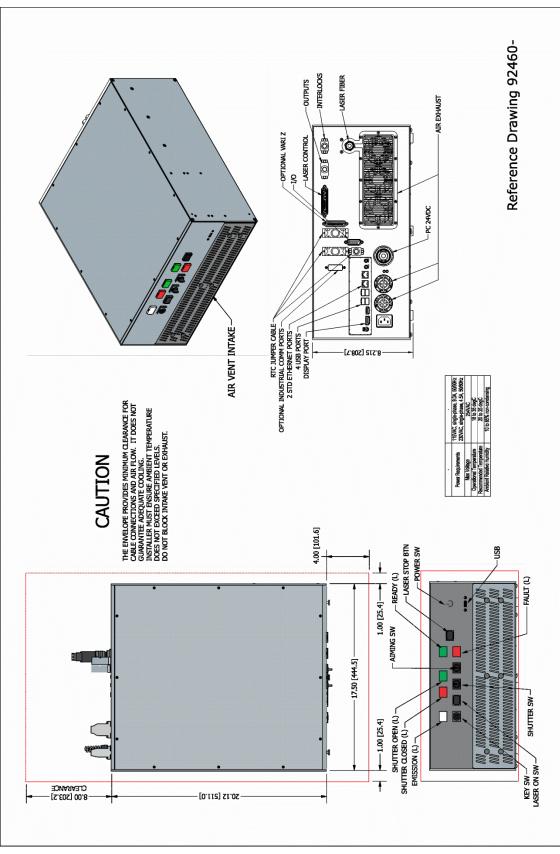
Avoid electromagnetic fields and static electricity in or around the Vari-Z marking head and its controller board.

- 1. Ensure sufficient clearance exists on all sides of the laser marking head to allow for proper air circulation and to permit proper installation of applicable cables. See *Laser Marking Head Dimensions* drawings for details.
- 2. Place the laser marking head on a suitable mounting surface. Secure the laser marking head to the mounting surface using the factory-tapped mounting holes provided in the marking head base plate.
- 3. Ensure sufficient clearance exists on all sides of the laser controller to allow for proper air circulation and to permit proper installation of applicable cables. See the *F14B Laser Controller Dimensions* drawing for details.
- Place the laser controller, monitor, and keyboard in the desired location. Locate the controller as close as practical to the laser marking head.
- 5. Connect the laser marking head to a customer-supplied shutter monitor.
- 6. Connect the laser marking head to a customer-supplied shutter interlock.
- 7. Connect all remaining system cables.



F100DSZ, and F100DSZV Laser Marking Head Dimensions

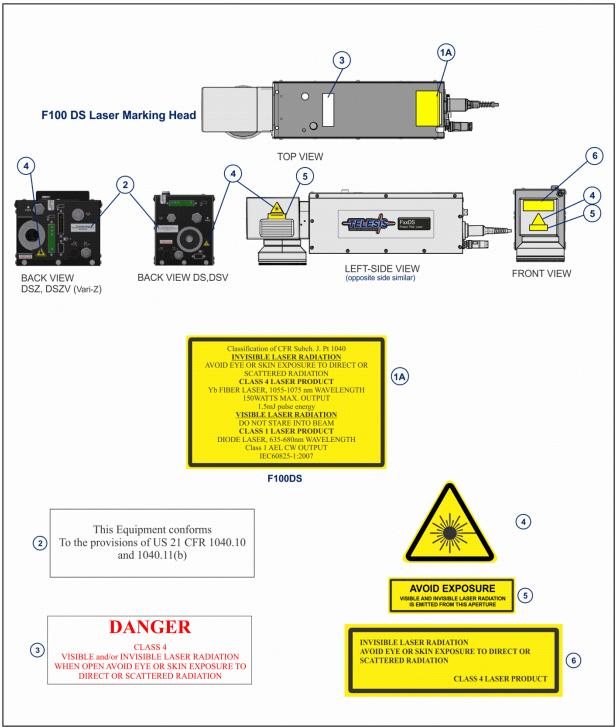




F14B Laser Controller Dimensions

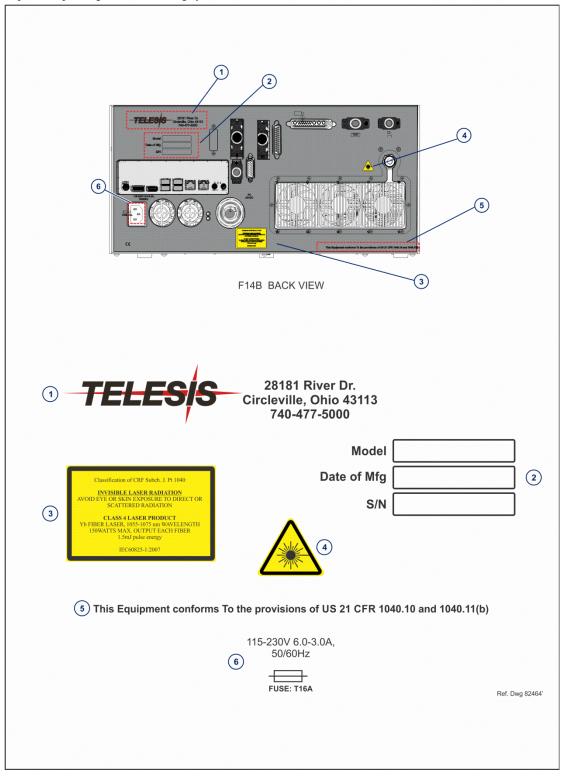
F100DS LASER MARKING HEAD LABELS

The following illustration shows the labels and their locations on the F100 laser marking heads. Familiarize yourself with the laser labels and their locations prior to operating the laser marking system.



F14B LASER CONTROLLER SAFETY LABELS

The following illustration shows the labels and their locations on the F14B laser controller. Familiarize yourself with the laser labels and their locations prior to operating the laser marking system.



F100 LASER MARKING HEAD

The laser marking head includes the shutter assembly, visible red aiming diode, circuit board, galvanometer assembly, and the flatfield lens. The beam collimator and isolator (at the end of the fiber optic cable) are enclosed within the laser marking head and cannot be removed.

Visible Red Aiming Diode

The laser marking head produces a visible red diode that can be viewed on the work surface without protective safety goggles. This provides a safe and convenient aid for laser setup and part programming. Because the red beam is located after the shutter, the aiming diode can be used with the shutter opened or closed. Additionally, the visible red beam can be used with the lasing beam during the marking cycle. Note protective eyewear must always be worn when the laser is in operation.

Marking Field Size

The size of the marking field is dependent on type of lens installed on the laser marking head. See *F100 Laser Marking Head Specifications*.

Marking Depth

Laser parameters can be programmed by the operator to create depths ranging from simple surface discoloration, shallow laser etching, or deep laser engraving. Marking depth depends on several factors including material, lens type selected, and laser marking parameters. Contact Telesis for the proper setting for your application.

Flat-Field Lens

The flat-field lens is key to the marking performance of the system. This is the final coated optical lens the beam passes through before it strikes the marking target. This lens is called a *flat-field lens* because when the beam is focused, the focus lies in a plane perpendicular to the optical axis of the lens. To protect the final objective lens from dust and debris, a clear protective cover is inserted between the work area and the lens.

Shutter Monitor

The F100 laser marking head employs a self-monitoring safety circuit using two separate sensors to detect the closed-state of the laser shutter mechanism. The sensor signals can be monitored by a additional safety circuit at the DB9P Dual Sensor connector on the back panel of the laser marking head. When the shutter is open, the sensor feedback signals are OFF. When the shutter is closed, the sensor feedback signals are ON.

Shutter Interlock

The F100 series laser marking head employs a Shutter Interlock Input connector and a Shutter Interlock Output connector. An optional customer-supplied shutter interlock can be connected to the input connector. The Shutter Interlock cable (provided) connects the Output connector to the laser controller.

F14B LASER CONTROLLER

The laser controller houses the laser source unit, system circuit boards, galvo controller board, programmable logic controller, control relay, cooling fan, and 115/230 VAC IEC320 connector.

The laser controller also contains an embedded computer that runs the Merlin II LS laser marking software. Controllers used with Vari-Z markers contain an additional 3D galvo controller board to provide variable Z-axis features.

The front panel provides controls for the operator. See *Operator Control Panel* for details. The back of the controller provides an interface panel for connecting the laser marking head and other external devices. See *Interface (Back) Panel* for details.

Fiber Optic Cable Assembly

The lasing beam is delivered to the laser marking head from the laser controller through a fiber optic cable. One end of the fiber optic cable is permanently attached to the laser source unit inside the laser controller. The opposite end of the cable includes a beam collimator and isolator that is enclosed within and pre-attached permanently to the laser marking head assembly.

The standard fiber optic cable for the F100DS laser is 3 m (8.989 ft) long with a 5 m (16.4 ft) option

To prevent back reflections, an *optical isolator* is used in all F100 laser marking systems. Installed on the laser marking head end of the fiber optic cable, the isolator functions as a one-way check valve allowing laser light to exit the laser but not return to the laser's most sensitive optical components.

Operator Control Panel

The front panel control module includes the system key switch, power on switch, laser off push button, manual safety shutter control, aiming diode on/off control, air filter and indicators lights (open/closed status, emission, ready, and fault).

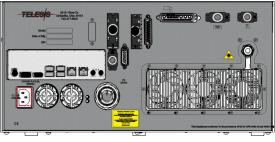
For convenience, the front panel provides a USB port for use with optional Telesis software.



F14B Laser Controller–Front Panel

Interface (Back) Panel

The back panel of the controller provides a power entry module and a permanent pre-connected fiber optic cable. Connections are also available for the laser marking head cable, galvo control cable, and, if implemented, a Vari-Z control cable.



F14B Laser Controller–Back Panel

The panel also provides a remote interlock connector and a remote pendant connector. An opto-isolated I/O connector is provided for connection to the remote I/O devices. Ethernet and USB ports are provided for other optional connections and usage with Telesis software. See *Remote Communications* for more information.

Connections for the embedded system computer are mounted on a sub-panel of the back panel. The separate panel allows you to connect a monitor, keyboard, and mouse directly to the laser controller.

System Computer

The laser controller contains an embedded IBM-compatible computer for running the Merlin II LS software.



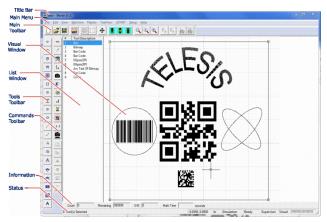
Merlin II LS software and associated applications are pre-installed on the embedded computer. The embedded system supports only Telesis-installed software and does not support user-installed programs.

All F14B laser controllers have the Merlin II LS software installed, and the system is tested prior to shipment. Warranties for the computer, keyboard, monitor, and peripherals default to the original equipment manufacturer. Peripheral equipment provided with the embedded controller includes a color monitor, mouse, and keyboard.

SYSTEM SOFTWARE

The powerful Telesis Merlin II LS laser marking software is a Windows®-based software package that comes with the standard laser marking system. It is a graphical user interface that makes marking pattern design quick and easy. The WYSIWYG (what-you-see-is-what-you-get) interface provides a to-scale image of the pattern as it is created. "Click and drag" to adjust field size, location, or orientation.

The Merlin II LS software includes tools to create and edit text, arc text, data matrix symbols, bar codes, rectangles, circles, ellipses, and lines. Existing DXF files can also be imported for marking. Non-printable fields can be created to display a graphical representation of the part being marked.



Merlin II LS User Interface

Remote Communications

The communication capability of the software allows you to control the laser from a remote source. Remote communications can be performed by connecting to a host computer, to an optional two-axis auxiliary controller, or to remote I/O devices.

Host Communications. Remote communications can be executed from a host computer using RS-232 or Ethernet (TCP/IP) connections to the system computer running the Merlin II LS software. The software provides parameters to define the data transmitted to and from the host.

Four-Axis Controller. Telesis offers an optional four-axis controller for all laser systems that use the Merlin II LS software. The auxiliary controller provides an interface for connecting a Z-axis tool post or a Theta-axis rotary drive unit. An optional board allows connection of two additional linear axes.

I/O Connector. The laser controller provides an opto-isolated DB26P I/O connector. Separate I/O racks or opto-isolated board assemblies are not required. In addition to the standard input and output signals, this connector provides two programmable inputs and two programmable outputs.

Communications Protocol

The host interface supports TCP/IP, and two communication protocols, Extended and Programmable, are provided through the Merlin II LS laser marking software.

Extended Protocol

Extended protocol provides two-way communication with error checking and transmission acknowledgment. It is designed to provide secure communications with an intelligent host device using pre-defined message formats and response formats where serial communication is a vital part of the marking operation.

All communications are carried out in a parent/child relationship with the host being the parent. Only the host has the ability to initiate communications. The Extended Protocol message is transmitted using the following format.

SOH TYPE [##] STX [DATA] ETX BCC CR

The message type is defined by a single, printable ASCII character. The Extend Protocol message types are:

Message Type 1 is not recommended for use. Use message type V when possible. If message type 1 is needed, contact your Telesis representative.

Message Type A updates the Offset Angle adjustment for the *primary* scan head ± 10 degrees.

Message Type a updates the Offset Angle adjustment for the secondary scan head ± 10 degrees.

Message Type C machine connection status.

Message Type E places the marking system Offline with the option of displaying an error message.

Message Type e displays a message provided in the data section if the system is idle. (Does not take system offline)

Message Type F updates the Focus offset parameter for the Laser head.

Message Type G initiates a print cycle.

Message Type H updates the Offset X/Y adjustment for the *primary* scan head.

Message Type h updates the Offset X/Y adjustment for the *secondary* scan head.

Message Type I polls the system for the I/O status.

Message Type L Get Laser description

Message Type K parks the Marking System. The Machine must be Online.

Message Type M sets the current Omni Serial Number to the integer value in the message data.

Message Type O places the marker online. This allows a host computer to reset and can be used to recover from a power outage when the marker is unattended.

Message Type P loads a pattern or polls the system for the current pattern name.

Message Type R allows a rotation angle to be specified via the host to rotate all pattern objects about the window origin.

Message Type Q provides data to the system query text buffer or polls the system for data.

Message Type S polls the system for the machine status. The machine status is returned to the host in an eight-character hexadecimal mask.

Message Type V provides data to a variable text string in the pattern or polls the pattern for data.

Message Type X sets the current pattern serial number to the integer value in the message data.

Programmable Protocol

Programmable protocol provides one-way (receive only) communication with no error checking or acknowledgment of the transmitted data. You can use Programmable protocol to extract a continuous portion of a message string to print. This can be used with a host computer or a bar code scanner. Note XON/XOFF Protocol applies even when Programmable protocol is selected.

The Programmable Protocol Message Type identifies the type of message sent from the host. It determines how the marker uses the data it extracts from the host message string when Programmable Protocol is used.

The Programmable Protocol message types are:

Message Type 49 (ASCII 1) overwrites the content of the first text-based field in the pattern with the data extracted from the host message.

Message Type 65 (ASCII A) updates the Offset Angle parameter for the marking window using data extracted from the host message.

Message Type 72 (ASCII H) updates the Offset X/Y parameters for the marking window using data extracted from the host message.

Message Type 80 (ASCII P) indicates the data extracted from the host message is the name of the pattern to be loaded.

Message Type 81 (ASCII Q) updates the text in the first query text buffer (buffer 0) with the data extracted from the host message.

Message Type 86 (ASCII uppercase V) updates the text in the first variable text field in the pattern with the data extracted from the host message.

Message Type 118 (ASCII lowercase v) updates the first text field encountered in the pattern that contains a variable text flag that matches the specified string length.

Message Type 0 (zero) indicates the host will provide the message type, field number (if applicable), and data. This delegates message type selection to the host on a message-by-message basis.

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